Title: Datasheet for TLV620612-Q1 Customer Contact: PCN Manager Dept: Quality Services Change Type:	Not	ification Number	:	2016:	112	1000	Notificatio	n Da	ate:	November 29, 2016	
Change Type: Design Wafer Bump Site Assembly Site Design Wafer Bump Material Assembly Materials Part number change Wafer Bump Material Mechanical Specification Test Site Wafer Fab Site Packing/Shipping/Labeling Test Process Wafer Fab Materials Description of Change: Wafer Fab Site Wafer Fab Materials Description of Change: Notification Details Exast Instruments Incorported is announcing an information only notification. The product datasheet(s) is updated as seen in the change revision history below: Exast Instruments Incorported is announcing an information only notification. The product datasheet(s) is updated as seen in the change revision history below: Exast Instruments Incorported is announcing an information only notification. The product datasheet(s) is updated as seen in the change revision history below: Exast Instruments Incorported is announcing an information only notification. Changed the maximum efficiency from 97% to 80% 1 1 Changed the maximum efficiency from 97% to 80% 1 1 Changed the input on the Recommended Operating Conditions to 12 V and removed all references to other output vidage (V ₀₁₇). Updated graphics where applicable. 5 Changed the Intermater from Revide of V in the Typical Characteristics sec	Title: Datasheet for TI		r TLV62	V620612-Q1		L					
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For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

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